

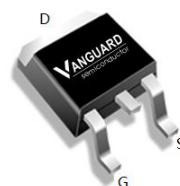


Features

- Enhancement mode
- Low on-resistance $R_{DS(on)}$ @ $V_{GS}=4.5$ V
- VitoMOS® II Technology
- 100% Avalanche test
- Pb-free lead plating; RoHS compliant

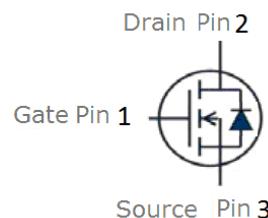
V_{DS}	60	V
$R_{DS(on),TYP}$ @ $V_{GS}=10$ V	7.5	mΩ
$R_{DS(on),TYP}$ @ $V_{GS}=4.5$ V	12.5	mΩ
I_D	60	A

TO-252



Halogen-Free

Part ID	Package Type	Marking	Tape and reel information
VSD009N06MS-G	TO-252	009N06M	2500pcs/Reel



Maximum ratings, at $T_A = 25^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	60	V
V_{GS}	Gate-Source voltage	± 20	V
I_S	Diode continuous forward current	$T_C = 25^\circ\text{C}$	A
I_D	Continuous drain current @ $V_{GS}=10$ V	$T_C = 25^\circ\text{C}$	A
		$T_C = 100^\circ\text{C}$	A
I_{DM}	Pulse drain current tested ①	$T_C = 25^\circ\text{C}$	A
I_{DSM}	Continuous drain current @ $V_{GS}=10$ V	$T_A = 25^\circ\text{C}$	A
		$T_A = 70^\circ\text{C}$	A
EAS	Avalanche energy, single pulsed ②	25	mJ
P_D	Maximum power dissipation	$T_C = 25^\circ\text{C}$	W
		$T_C = 100^\circ\text{C}$	W
P_{DSM}	Maximum power dissipation ③	$T_A = 25^\circ\text{C}$	W
		$T_A = 70^\circ\text{C}$	W
T_{STG}, T_J	Storage and Junction Temperature Range	-55 to 175	°C

Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	2.9	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	100	°C/W



Electrical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ $T_j=25^\circ\text{C}$ (unless otherwise stated)						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	60	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$	--	--	1	μA
	Zero Gate Voltage Drain Current($T_j=125^\circ\text{C}$)	$V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$	--	--	100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	--	--	± 100	nA
$V_{\text{GS(TH)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.3	1.8	2.5	V
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance ④	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=20\text{A}$	--	7.5	10	$\text{m}\Omega$
		$T_j=100^\circ\text{C}$	--	9.5	--	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance ④	$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=20\text{A}$	--	12.5	17	$\text{m}\Omega$
Dynamic Electrical Characteristics @ $T_j = 25^\circ\text{C}$ (unless otherwise stated)						
C_{iss}	Input Capacitance	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	1070	1255	1440	pF
C_{oiss}	Output Capacitance		530	625	720	pF
C_{rss}	Reverse Transfer Capacitance		--	20	30	pF
R_g	Gate Resistance	$f=1\text{MHz}$	--	0.9	--	Ω
$Q_g(10\text{V})$	Total Gate Charge	$V_{\text{DS}}=30\text{V}, I_{\text{D}}=20\text{A}, V_{\text{GS}}=10\text{V}$	--	23	--	nC
$Q_g(4.5\text{V})$	Total Gate Charge		--	11	--	nC
Q_{gs}	Gate-Source Charge		--	3.7	--	nC
Q_{gd}	Gate-Drain Charge		--	4.1	--	nC
Switching Characteristics						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=30\text{V}, I_{\text{D}}=20\text{A}, R_{\text{C}}=3\Omega, V_{\text{GS}}=10\text{V}$	--	7.4	--	ns
t_r	Turn-on Rise Time		--	31	--	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	20	--	ns
t_f	Turn-Off Fall Time		--	6.6	--	ns
Source- Drain Diode Characteristics@ $T_j = 25^\circ\text{C}$ (unless otherwise stated)						
V_{SD}	Forward on voltage	$I_{\text{SD}}=20\text{A}, V_{\text{GS}}=0\text{V}$	--	0.9	1.2	V
t_{rr}	Reverse Recovery Time	$T_j=25^\circ\text{C}, I_{\text{SD}}=20\text{A}, V_{\text{GS}}=0\text{V}$	--	24	--	ns
Q_{rr}	Reverse Recovery Charge		--	11	--	nC

NOTE:

- ① Repetitive rating: pulse width limited by max junction temperature.
- ② Limited by $T_{j\text{max}}$, starting $T_j = 25^\circ\text{C}$, $L = 0.5\text{mH}$, $R_g = 25\Omega$, $I_{AS} = 10\text{A}$, $V_{GS} = 10\text{V}$. Part not recommended for use above this value
- ③ The power dissipation P_{DSM} is based on $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C .
- ④ Pulse width $\leq 380\mu\text{s}$; duty cycle $\leq 2\%$.



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VSD009N06MS-G
60V/60A N-Channel Advanced Power MOSFET

Typical Characteristics

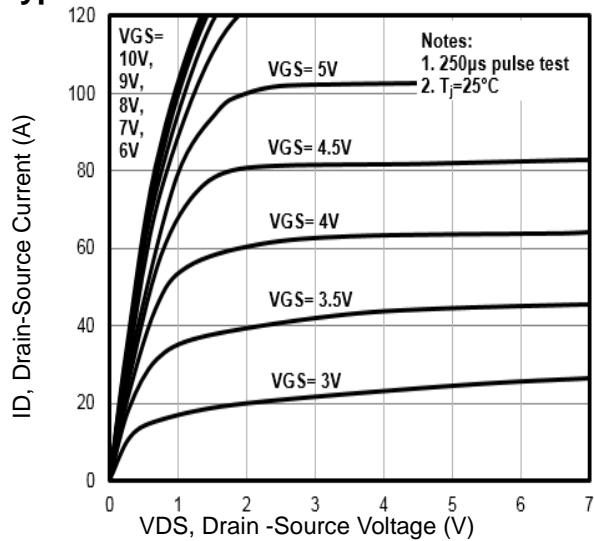


Fig1. Typical Output Characteristics

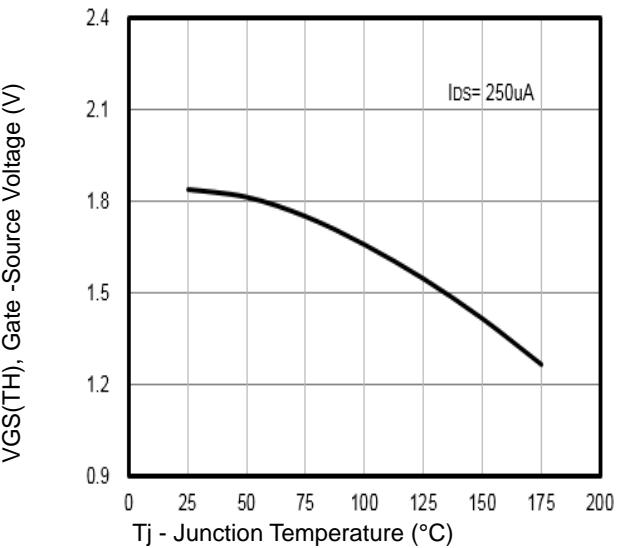


Fig2. $V_{GS(TH)}$ Gate -Source Voltage Vs. T_j

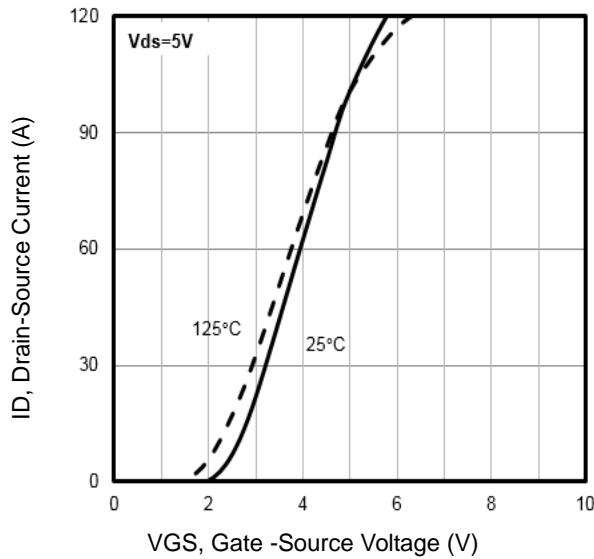


Fig3. Typical Transfer Characteristics

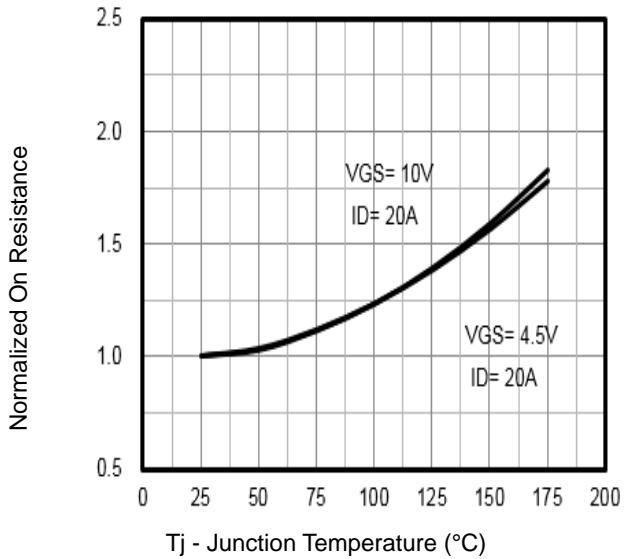


Fig4. Normalized On-Resistance Vs. T_j

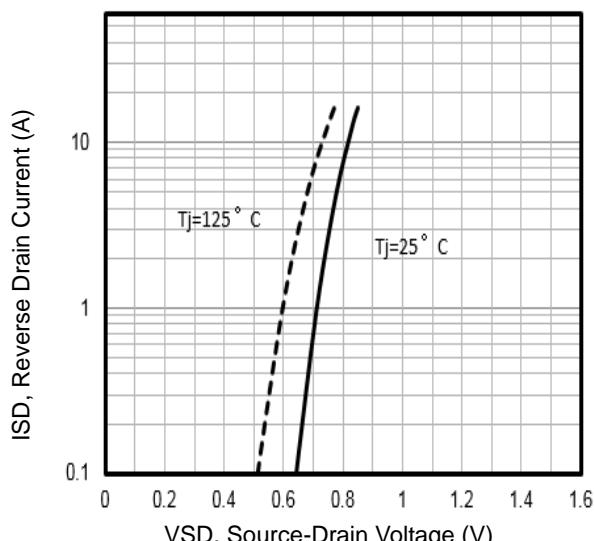


Fig5. Typical Source-Drain Diode Forward Voltage

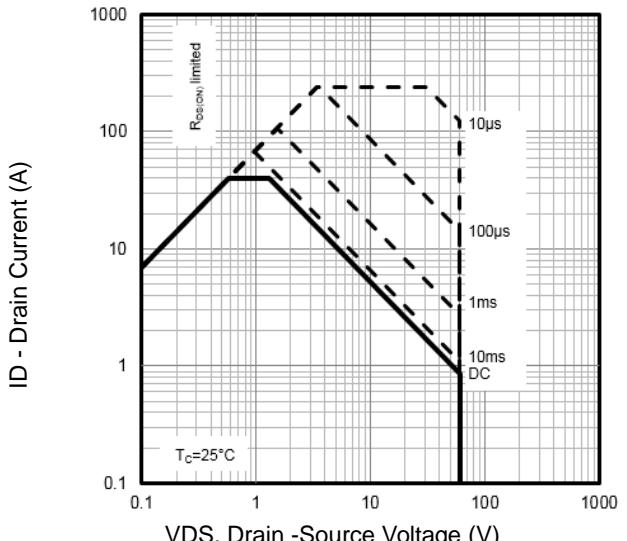


Fig6. Maximum Safe Operating Area



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VSD009N06MS-G
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Typical Characteristics

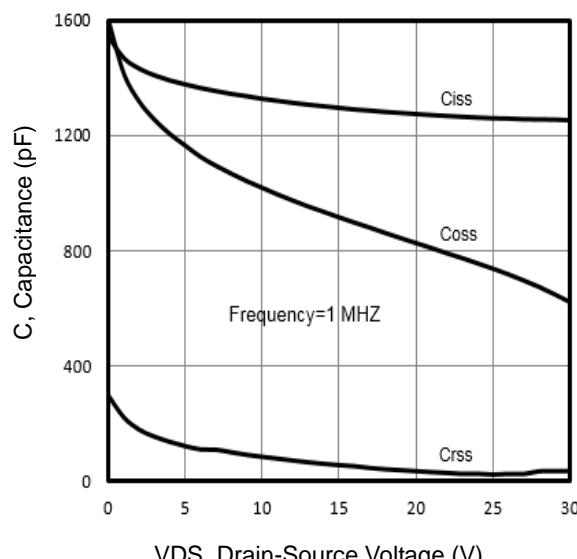


Fig7. Typical Capacitance Vs. Drain-Source Voltage

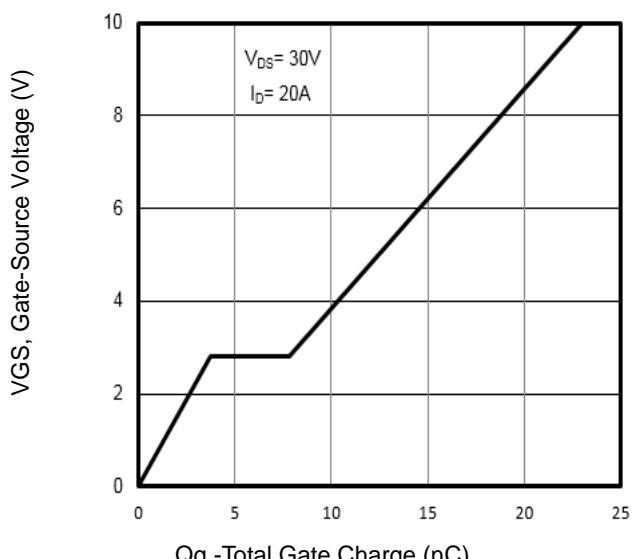


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

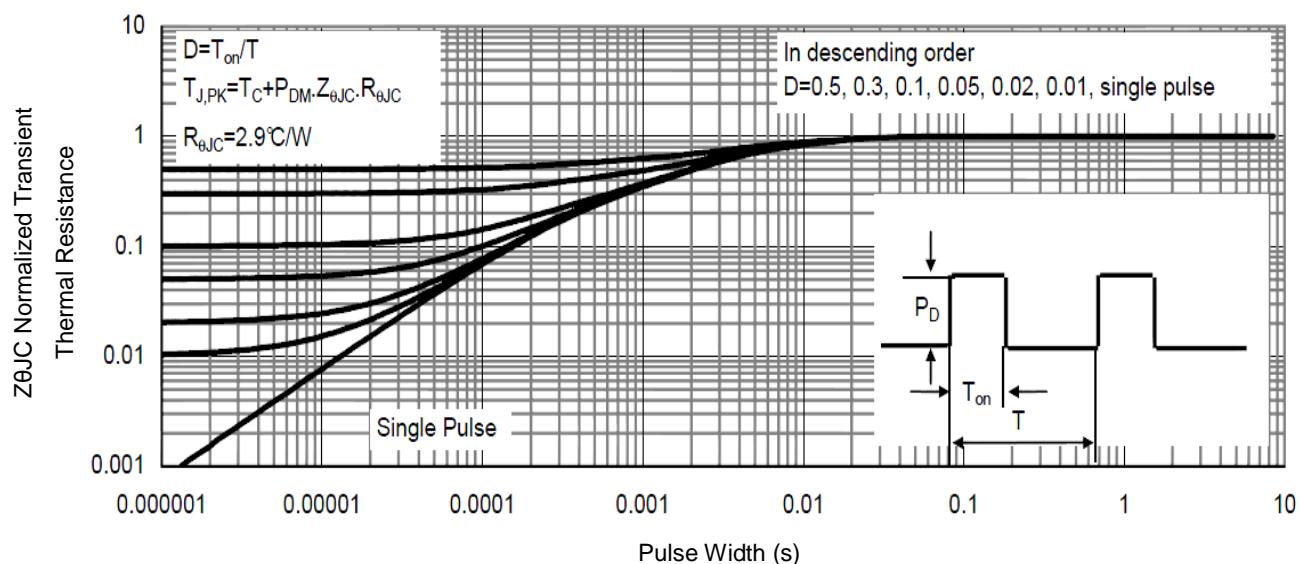


Fig9. Normalized Maximum Transient Thermal Impedance

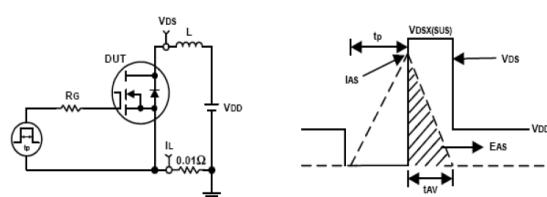


Fig10. Unclamped Inductive Test Circuit and waveforms

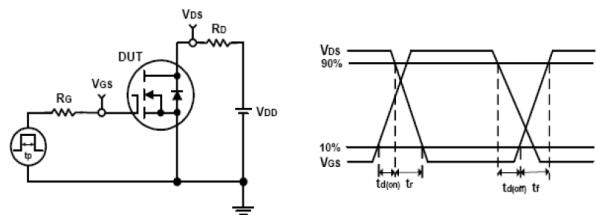


Fig11. Switching Time Test Circuit and waveforms

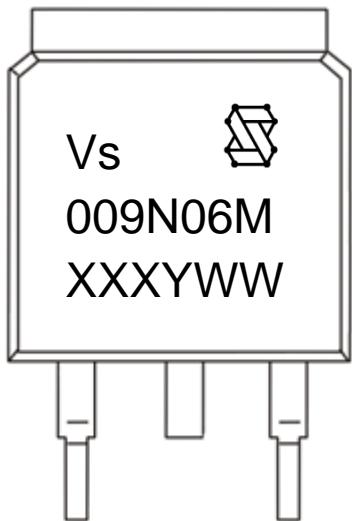


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VSD009N06MS-G

60V/60A N-Channel Advanced Power MOSFET

Marking Information



1st line: Vanguard Code (Vs), Vanguard Logo

2nd line: Part Number (009N06M)

3rd line: Date code (XXXYWW)

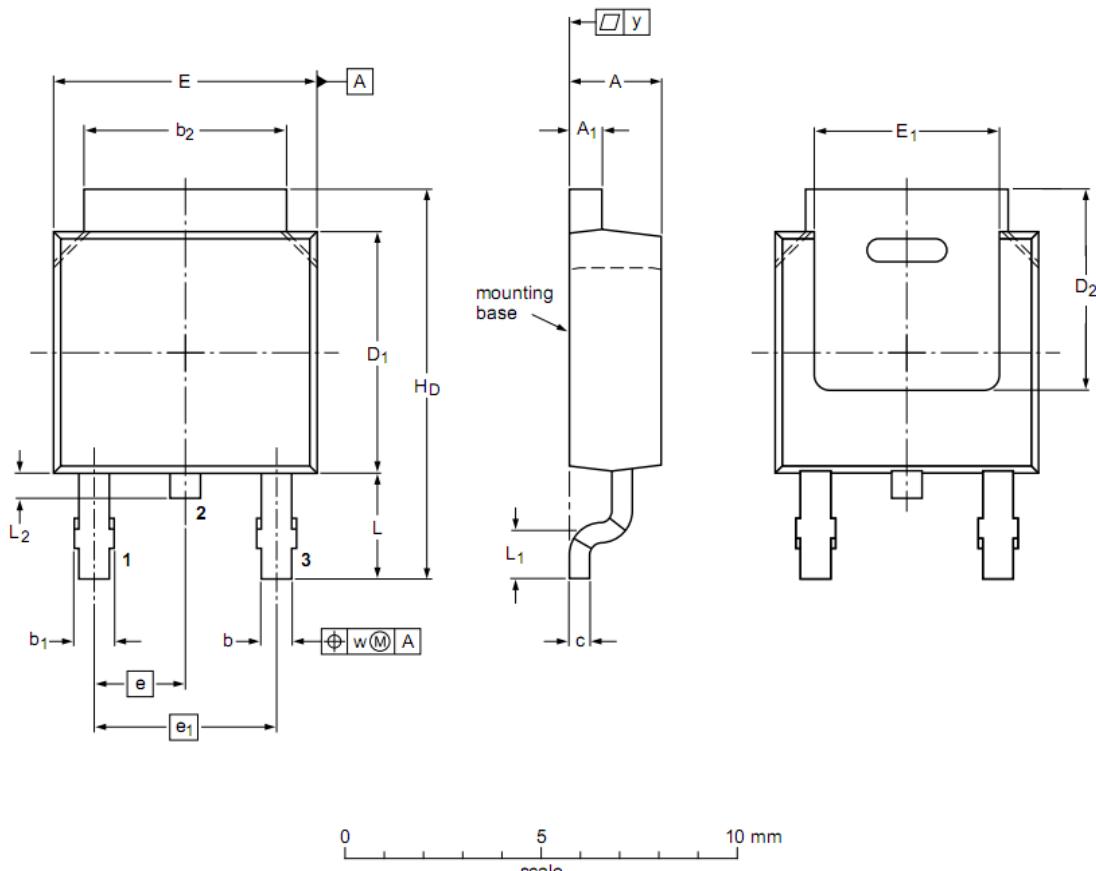
XXX: Wafer Lot Number Code , code changed with Lot Number

Y: Year Code, (e.g. E=2017, F=2018, G=2019, H=2020, etc)

WW: Week Code (01 to 53)



TO-252 Package Outline Data



Symbol	Dimensions (unit: mm)		
	Min	Typ	Max
A	2.20	2.30	2.38
A ₁	0.46	0.50	0.63
b	0.64	0.76	0.89
b ₁	0.77	0.85	1.14
b ₂	5.00	5.33	5.46
c	0.458	0.508	0.558
D ₁	5.98	6.10	6.223
D ₂	5.21	--	--
E	6.40	6.60	6.731
E ₁	4.40	--	--
e	2.286 BSC		
e ₁	--	4.57	--
H _b	9.40	10.00	10.40
L	2.743 REF		
L ₁	1.40	1.52	1.77
L ₂	0.50	0.80	1.01
w	--	0.20	--
y	--	--	0.20

Notes:

1. Refer to JEDEC TO-252 variation AA
2. Dimension "E" does NOT include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.1524mm per side.
3. Dimension "D₁" does NOT include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.1524mm per end.

Customer Service

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